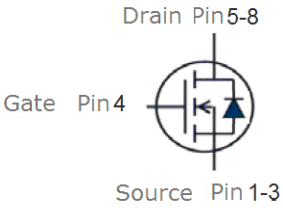
Features

- N-Channel，5V Logic Level Control
- Enhancement mode
- Low on-resistance $R_{DS(on)}$ @ V_{GS}=4.5 V
- VitoMOS® Ⅱ Technology
- 100% Avalanche test
- Pb-free lead plating; RoHS compliant

Pb-Free RoHS HF Halogen-Free

V_{DS}	100	V
$R_{DS(on),TYP}$@ V_{GS}=10 V	6	mΩ
$R_{DS(on),TYP}$@ V_{GS}=4.5 V	10	mΩ
I_D	85	A

PDFN5x6



Part ID	Package Type	Marking	Tape and reel information
VSP008N10MS	PDFN5x6	008N10M	3000PCS/Reel

Maximum ratings, at T_A =25°C, unless otherwise specified

Symbol	Parameter		Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage		100	V
VGS	Gate-Source voltage		±20	V
I_S	Diode continuous forward current	T_C =25°C	85	A
I_D	Continuous drain current @VGS=10V	T_C =25°C	85	A
		T_C =100°C	53	A
I_{DM}	Pulse drain current tested ①	T_C =25°C	340	A
I_{DSM}	Continuous drain current @VGS=10V	T_A=25°C	21	A
		T_A=70°C	16.5	A
EAS	Avalanche energy, single pulsed ②		104	mJ
P_D	Maximum power dissipation	T_C =25°C	69	W
P_{DSM}	Maximum power dissipation③	T_A=25°C	4	W
T_{STG}, T_J	Storage and Junction Temperature Range		-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	30	°C/W

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ T_j=25°C (unless otherwise stated)						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250μA	100	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=100V,V_{GS}=0V	--	--	1	μA
	Zero Gate Voltage Drain Current(T_j=125℃)	V_{DS}=100V,V_{GS}=0V	--	--	100	μA
I_{GSS}	Gate-Body Leakage Current	V_{GS}=±20V,V_{DS}=0V	--	--	±100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	V_{DS}=V_{GS},I_D=250μA	1.2	1.7	2.3	V
$R_{DS(ON)}$	Drain-Source On-State Resistance④	V_{GS}=10V, I_D=20A	--	6	8	mΩ
$R_{DS(ON)}$	Drain-Source On-State Resistance④	V_{GS}=4.5V, I_D=15A	--	10	12	mΩ
Dynamic Electrical Characteristics @ T_j = 25°C (unless otherwise stated)						
C_{iss}	Input Capacitance	V_{DS}=30V,V_{GS}=0V, f=1MHz	1100	1720	2300	pF
C_{oss}	Output Capacitance		600	1100	1600	pF
C_{rss}	Reverse Transfer Capacitance		--	75	130	pF
R_g	Gate Resistance	f=1MHz	--	2.3	--	Ω
Q_g	Total Gate Charge	V_{DS}=30V,I_D=20A, V_{GS}=10V	--	31	--	nC
Q_{gs}	Gate-Source Charge		--	7.8	--	nC
Q_{gd}	Gate-Drain Charge		--	7.5	--	nC
Switching Characteristics						
$t_{d(on)}$	Turn-on Delay Time	V_{DD}=30V, I_D=20A, R_G=3Ω, V_{GS}=10V	--	9.9	--	nS
t_r	Turn-on Rise Time		--	6	--	nS
$t_{d(off)}$	Turn-Off Delay Time		--	29.3	--	nS
t_f	Turn-Off Fall Time		--	8.5	--	nS
Source- Drain Diode Characteristics@ T_j = 25°C (unless otherwise stated)						
V_{SD}	Forward on voltage	I_{SD}=20A,V_{GS}=0V	--	0.8	1.2	V
t_{rr}	Reverse Recovery Time	T_j=25℃,I_{sd}=20A, V_{GS}=0V di/dt=500A/μs	--	21	--	nS
Q_{rr}	Reverse Recovery Charge			38.7		nC

NOTE:

① Repetitive rating; pulse width limited by max junction temperature.

② Limited by T_{Jmax}, starting T_J = 25°C, L = 0.5mH, R_G = 25Ω, I_{AS} = 16A, V_{GS} =10V. Part not recommended for use above this value.

③The power dissipation P_{DSM} is based on $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C.

④Pulse width ≤ 300μs; duty cycle≤ 2%.

Typical Characteristics

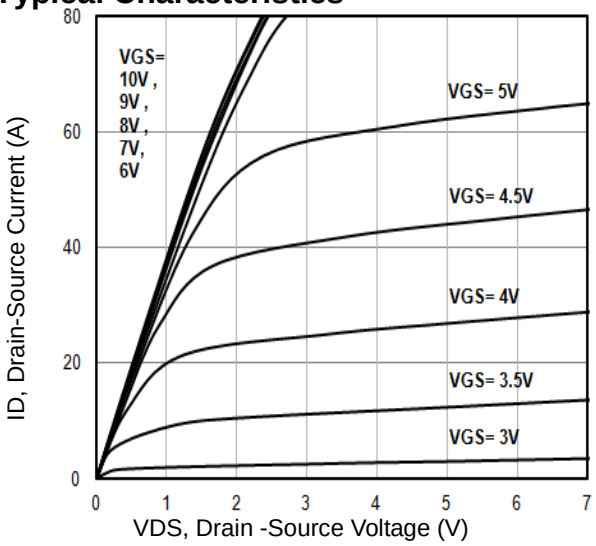


Fig1. Typical Output Characteristics

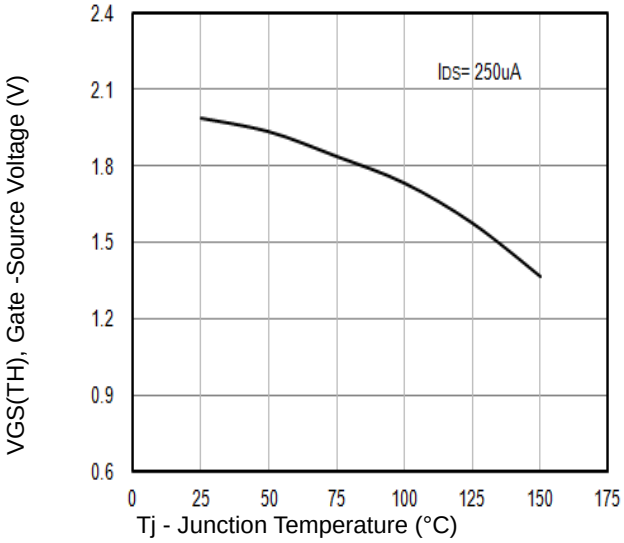


Fig2. $V_{GS(TH)}$ Gate -Source Voltage Vs.Tj

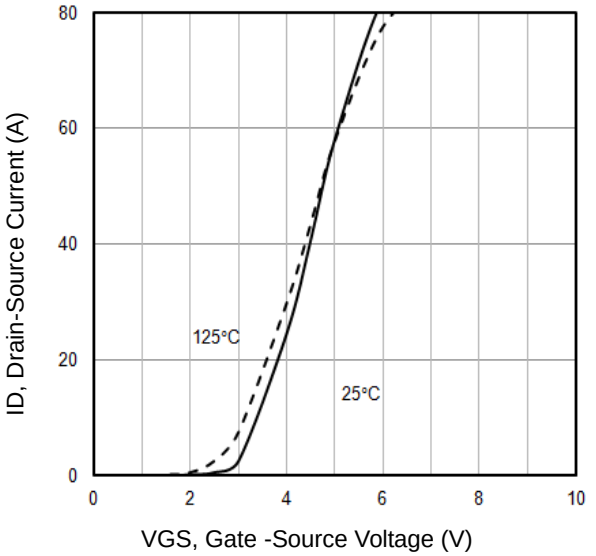


Fig3. Typical Transfer Characteristics

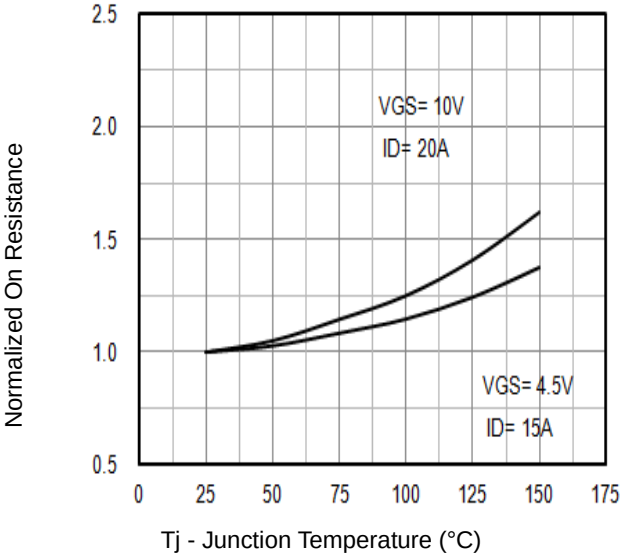


Fig4. Normalized On-Resistance Vs. Tj

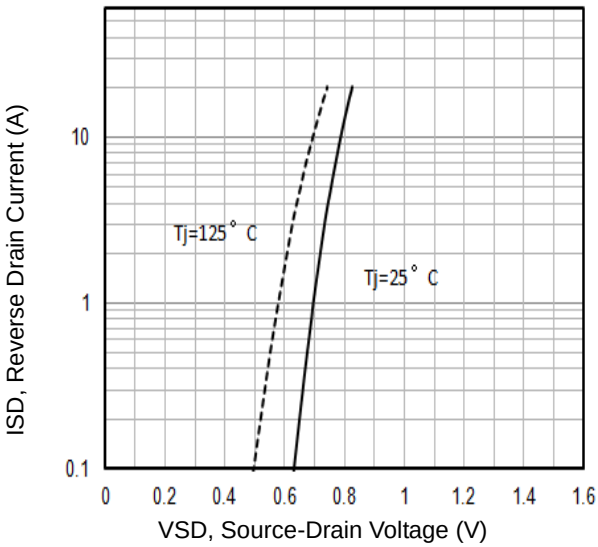


Fig5. Typical Source-Drain Diode Forward Voltage

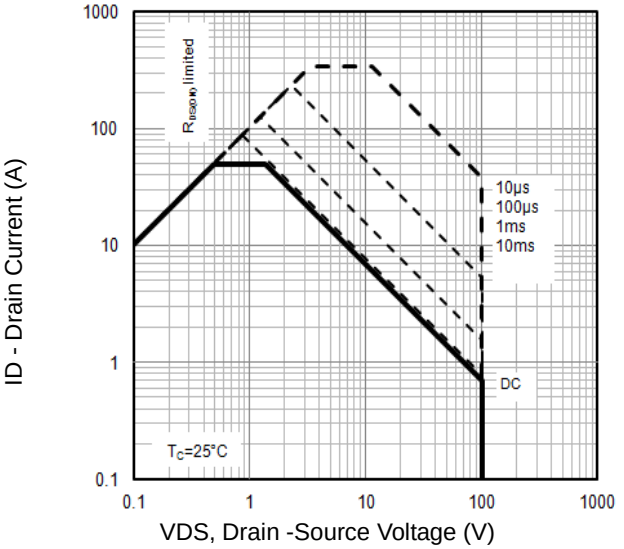


Fig6. Maximum Safe Operating Area

Typical Characteristics

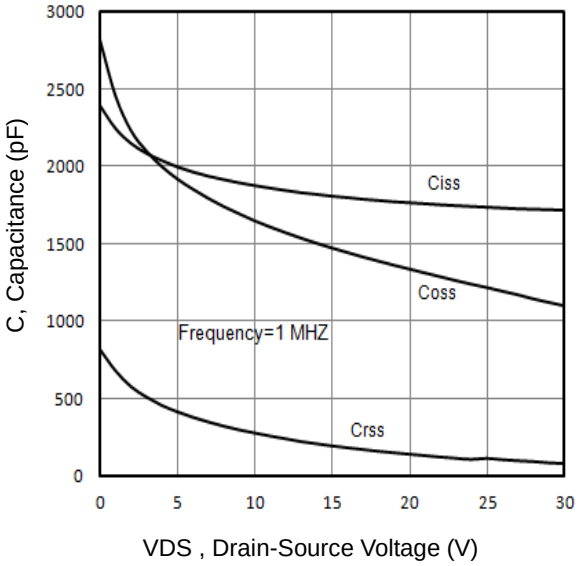


Fig7. Typical Capacitance Vs.Drain-Source Voltage

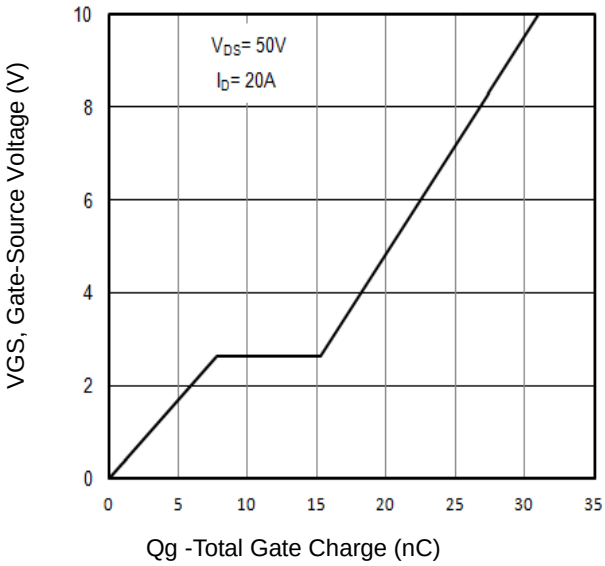


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

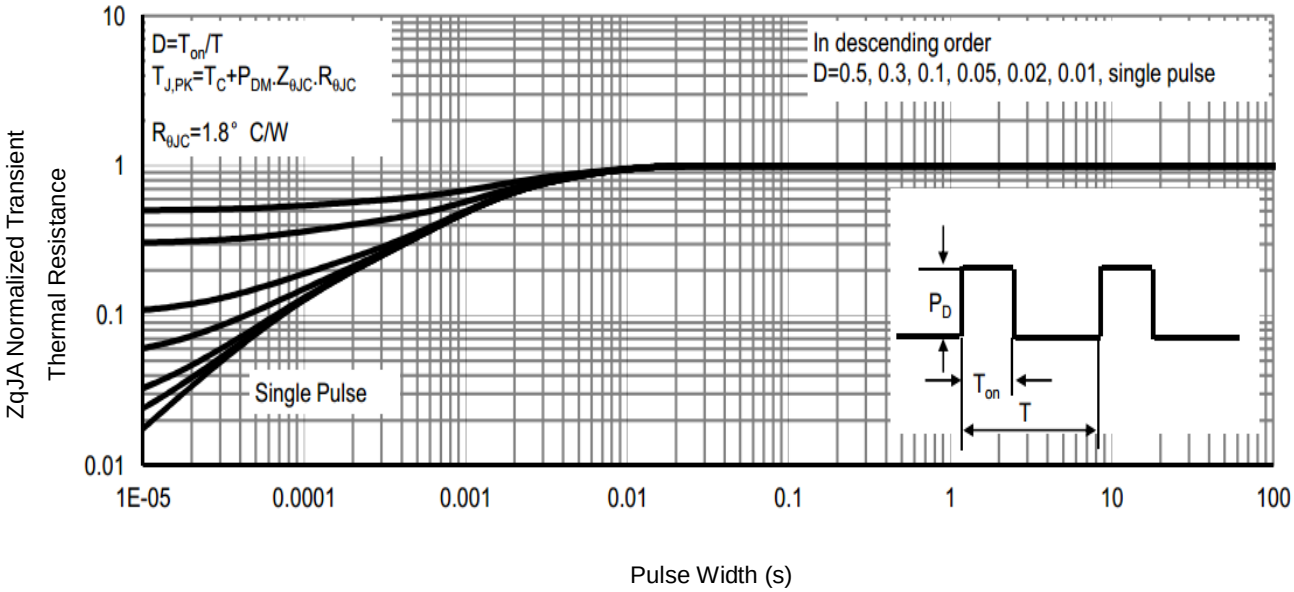


Fig9. Normalized Maximum Transient Thermal Impedance

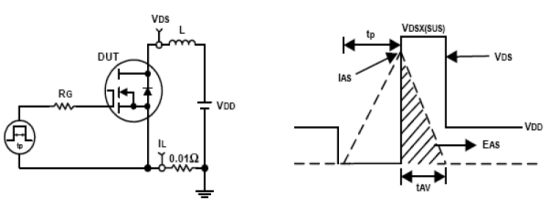


Fig10. Unclamped Inductive Test Circuit and waveforms

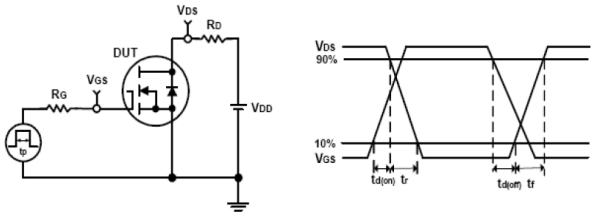
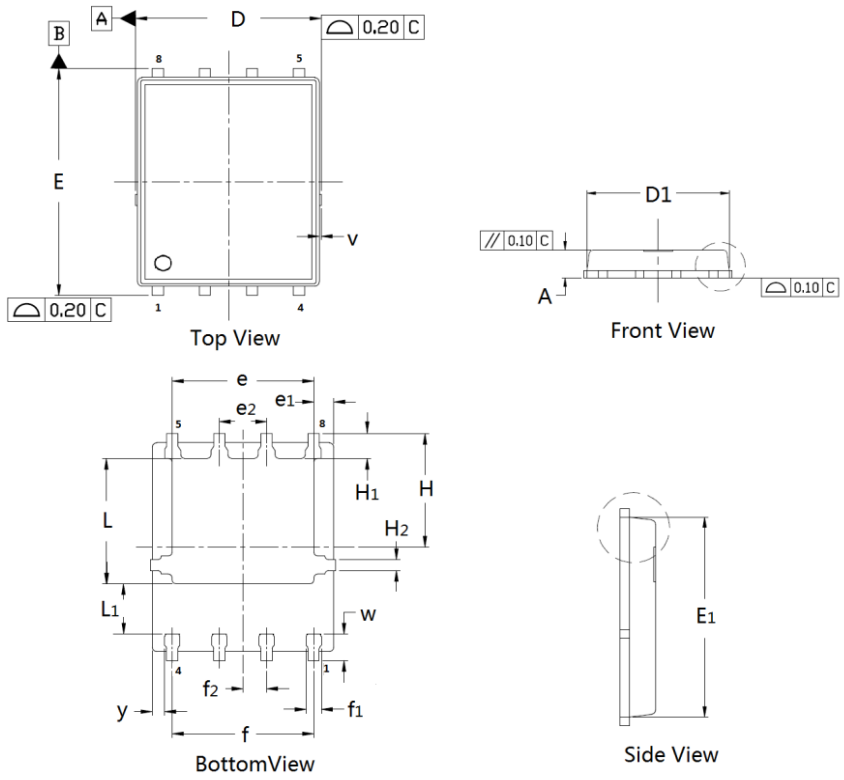


Fig11. Switching Time Test Circuit and waveforms

PDFN5×6 Package Outline Data



DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	0.90	1.02	1.10	**D**	4.90	4.98	5.10
D_1	4.80	4.89	5.00	**E**	6.00	6.11	6.20
E_1	5.65	5.74	5.85	**e**	3.72	3.80	3.92
e_1	--	0.54	--	**e_2**	--	1.27	--
f	--	3.82	--	**f_1**	0.31	0.37	0.51
f_2	--	0.64	--	**H**	--	3.15	--
H_1	0.59	0.63	0.79	**H_2**	0.26	0.28	0.32
L	3.38	3.45	3.58	**L_1**	--	1.39	--
v	--	0.13	--	**w**	0.64	0.68	0.84
y	--	0.34	--		--		--

Customer Service

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